

3D VIEW

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A1			UPDATE SOME DETAILS	05/19'23	Derek

ORDERING INFORMATION

WB200H560 - XX (00 R)
① ② ③ ④

① PRODUCT SERIES:

Wire To Board Connector
Pitch 2.0mm /Height 5.60mm
Right Angle-Single Row

② NUMBER OF CONTACTS:

SEE DIM. TABLE

CUSTOMER DRAWING

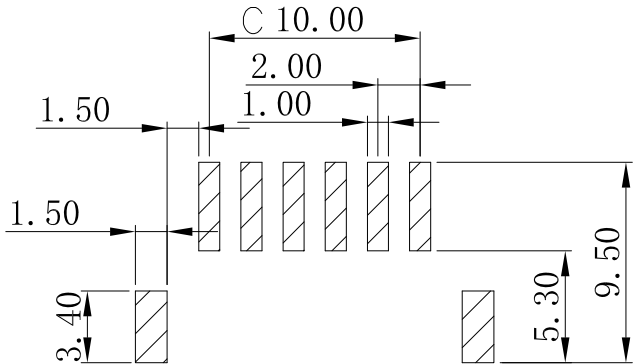
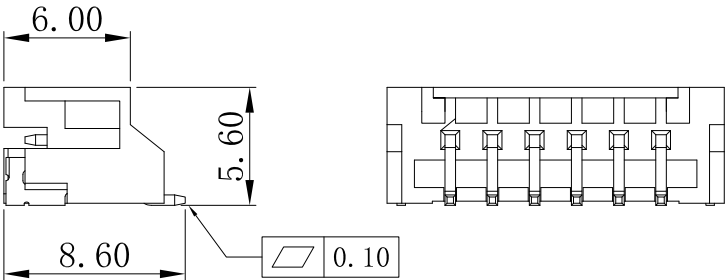
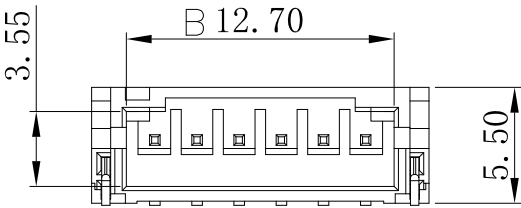
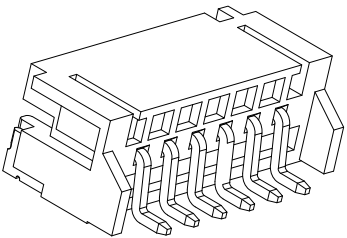
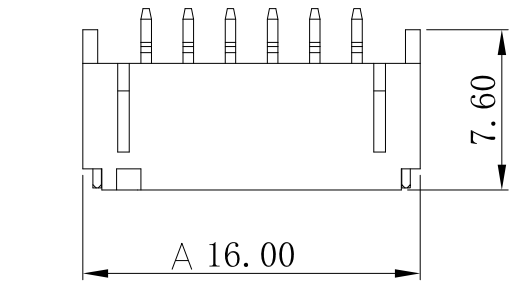
RoHS Compliant

③ PLATING :

00: Tin plated.

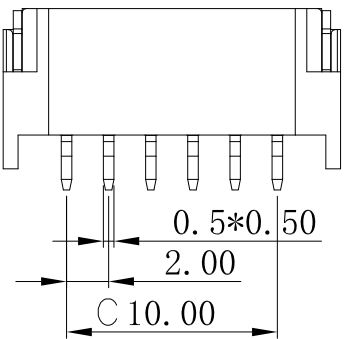
④ PACKING :

R: Reel.



RECOMMEND PCB LAYOUT

GENERAL TOLERANCE: ±0.05



DIMENSION TABLE:

PIN NO	A	B	C
02	8.00	4.70	2.00
03	10.00	6.70	4.00
04	12.00	8.70	6.00
05	14.00	10.70	8.00
06	16.00	12.70	10.00
07	18.00	14.70	12.00
08	20.00	16.70	14.00
09	22.00	18.70	16.00
10	24.00	20.70	18.00

DIM	TOL	DIM	TOL
X.X	±0.20	X.X*	±3.0*
X.XX	±0.10	X.XX*	±2.0*
X.XXX	±0.05	X.XXX*	±1.0*

NOTES:

- 1.Material:
1. Contact: Copper Alloy.
2. Insulator: High Temp, UL94V-0.
3. Fit: Copper Alloy.

2.Plating:

1. Contact: Tin over Nickel under-plated overall.
2. Fit: Tin over Nickel under-plated overall.

SUNFUN			SUNFUN TECHNOLOGY LTD		
DRAW NO.	WB200H560(A1)	DATE	MATERIAL:	SEE NOTES	DRAW NAME:
DESIGN:	Derek	05/19'23	FINISH:	SEE NOTES	Wire To Board CONN: Pitch 2.0mm /Height 5.60mm Right Angle-Single Row
CHECK:	Derek	05/19'23	FILE:	WB200H560(A1)	MODEL: P2.0 WTB CONN
REVIEW:	Frank	05/19'23	P/N:	WB200H560-XX(00R)	UNIT: mm
APPROVED	Frank	05/19'23	REV. A1	SCALE	SHEET: 1/1